Transfer field TF-P-SI-020-L

Item 48738





- Contact module for reliable transmission of signals wheen contacting from the top side
- Quick, easy, freely adjustable installation
- Equipped with INGUN contact terminals

Application

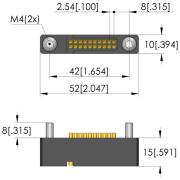
Transfer fields (TF) are used as contact modules to reliably transmit signals from top-side contacting. The signal transfer is spring-loaded, with the advantage that the exchangeable kit can be exchanged quickly and easily in interchangeable kit test fixtures without having to disconnect the wiring to the DUT. Transfer fields are typically mounted on the pressure-frame plate.















General data

Product group: Series: Туре:

Version: Accessory type: Scope of delivery:

Width: Height: Weight:

Min. temperature: Max. temperature: RoHS-compliant:

Yes

Transfer fields TF-SI

Device under test (DUT) side Customising accessories Fully loaded with KT-254 L3 E02 10 mm [.393 in] 15 mm [.59 in] 0.02 kg [.044 lbs] 10 °C [50 °F] 60 °C [140 °F]

Compatible with

Exchangeable kits version: MA exchangeable kits (ATS MA): For dual-stage contacting:

Connection: Number of poles: Installation grid: Length: Outer dimensionS (WxDxH): No limitations ATS MAXX Yes

Technical data

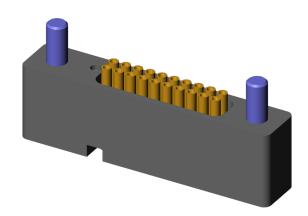
Solder connection 20 2.54 mm [.1 in] 52 mm [2.04 in] 52 x 10 x 15 mm [2.04 x .393 x .59 in]

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INGUN Prüfmittelbau GmbH

Max-Stromeyer-Straße 162 78467, Constance, Germany Phone +49 7531 8105-0 Customer hotline +49 7531 8105-888 Fax +49 7531 8105-65 info@ingun.com





